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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Active
Number of LABs/CLBs	4224
Number of Logic Elements/Cells	-
Total RAM Bits	55296
Number of I/O	138
Number of Gates	250000
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 70°C (TA)
Package / Case	256-LBGA
Supplier Device Package	256-FPBGA (17x17)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/ax250-fgg256

User-Defined Supply Pins

VREF Supply Voltage

Reference voltage for I/O banks. VREF pins are configured by the user from regular I/O pins; VREF pins are not in fixed locations. There can be one or more VREF pins in an I/O bank.

Global Pins

HCLKA/B/C/D Dedicated (Hardwired) Clocks A, B, C and D

These pins are the clock inputs for sequential modules or north PLLs. Input levels are compatible with all supported I/O standards. There is a P/N pin pair for support of differential I/O standards. Single-ended clock I/Os can only be assigned to the P side of a paired I/O. This input is directly wired to each R-cell and offers clock speeds independent of the number of R-cells being driven. When the HCLK pins are unused, it is recommended that they are tied to ground.

CLKE/F/G/H Routed Clocks E, F, G, and H

These pins are clock inputs for clock distribution networks or south PLLs. Input levels are compatible with all supported I/O standards. There is a P/N pin pair for support of differential I/O standards. Single-ended clock I/Os can only be assigned to the P side of a paired I/O. The clock input is buffered prior to clocking the R-cells. When the CLK pins are unused, Microsemi recommends that they are tied to ground.

JTAG/Probe Pins

PRA/B/C/D Probe A, B, C and D

The Probe pins are used to output data from any user-defined design node within the device (controlled with Silicon Explorer II). These independent diagnostic pins can be used to allow real-time diagnostic output of any signal path within the device. The pins' probe capabilities can be permanently disabled to protect programmed design confidentiality. The probe pins are of LVTTTL output levels.

TCK Test Clock

Test clock input for JTAG boundary-scan testing and diagnostic probe (Silicon Explorer II).

TDI Test Data Input

Serial input for JTAG boundary-scan testing and diagnostic probe. TDI is equipped with an internal 10 k Ω pull-up resistor.

TDO Test Data Output

Serial output for JTAG boundary-scan testing.

TMS Test Mode Select

The TMS pin controls the use of the IEEE 1149.1 boundary-scan pins (TCK, TDI, TDO, TRST). TMS is equipped with an internal 10 k Ω pull-up resistor.

TRST Boundary Scan Reset Pin

The TRST pin functions as an active-low input to asynchronously initialize or reset the boundary scan circuit. The TRST pin is equipped with a 10 k Ω pull-up resistor.

Special Functions

LP Low Power Pin

The LP pin controls the low power mode of Axcelerator devices. The device is placed in the low power mode by connecting the LP pin to logic high. To exit the low power mode, the LP pin must be set Low. Additionally, the LP pin must be set Low during chip powering-up or chip powering-down operations. See "Low Power Mode" on page 2-106 for more details.

NC No Connection

This pin is not connected to circuitry within the device. These pins can be driven to any voltage or can be left floating with no effect on the operation of the device.

User I/O Naming Conventions

Due to the complex and flexible nature of the Axcelerator family's user I/Os, a naming scheme is used to show the details of the I/O. The naming scheme explains to which bank an I/O belongs, as well as the pairing and pin polarity for differential I/Os (Figure 2-7).

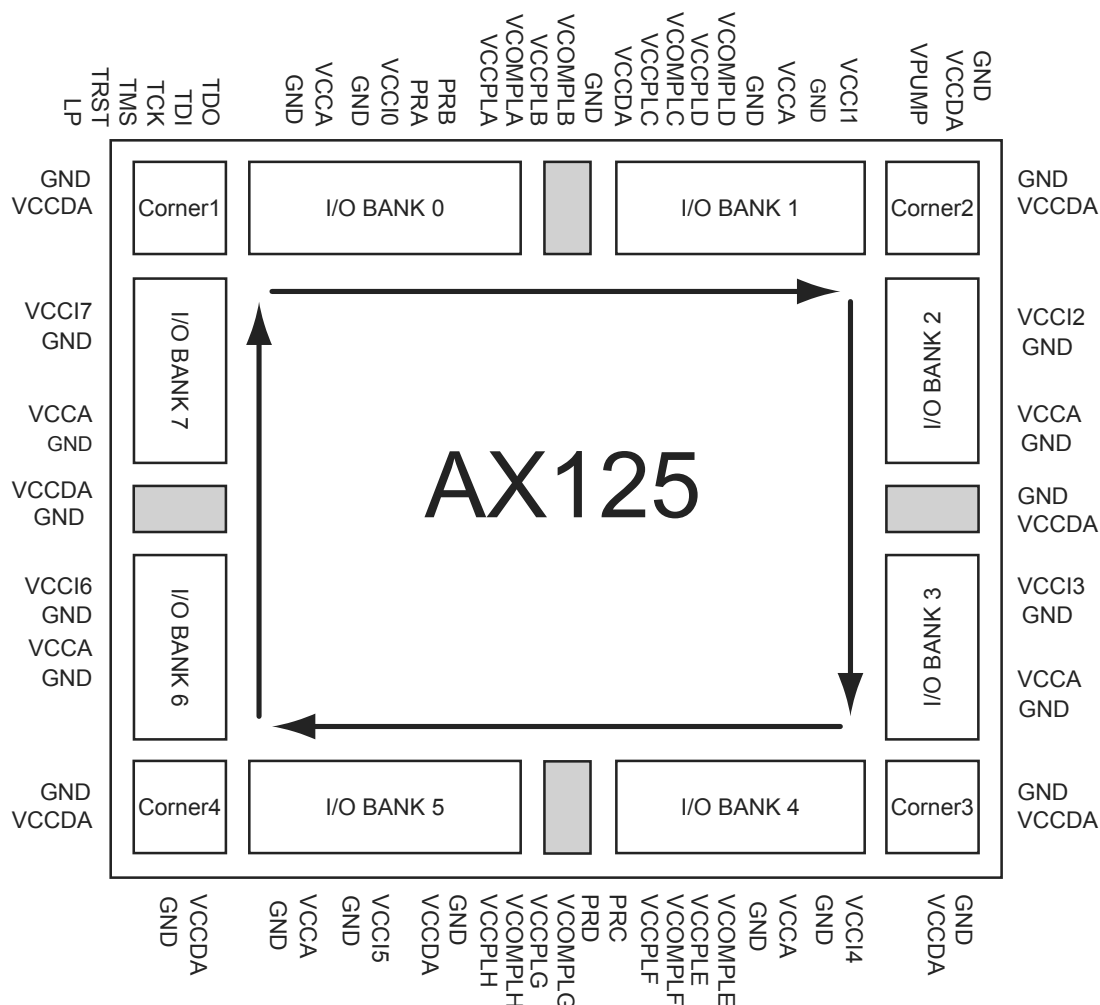
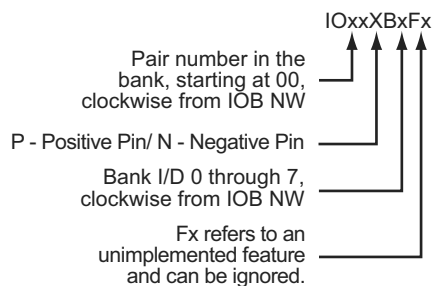


Figure 2-7 • I/O Bank and Dedicated Pin Layout



Examples:

IO12PB1F1 is the positive pin of the thirteenth pair of the first I/O bank (IOB NE). IO12PB1 combined with IO12NB1 form a differential pair.

For those I/Os that can be employed either as a user I/O or as a special function, the following nomenclature is used:

IOxxXBxFx/special_function_name

IOxxPB1Fx/xCLKx this pin can be configured as a clock input or as a user I/O.

Figure 2-8 • General Naming Schemes

Table 2-22 • 3.3 V LVTTTL I/O Module

Worst-Case Commercial Conditions VCCA = 1.425 V, VCCI = 3.0 V, T_J = 70°C (continued)

		–2 Speed		–1 Speed		Std Speed		
Parameter	Description	Min.	Max.	Min.	Max.	Min.	Max.	Units
LVTTTL Output Drive Strength =3 (16 mA) / High Slew Rate								
t _{DP}	Input Buffer		1.68		1.92		2.26	ns
t _{PY}	Output Buffer		3.12		3.56		4.18	ns
t _{ENZL}	Enable to Pad Delay through the Output Buffer—Z to Low		3.54		4.04		4.75	ns
t _{ENZH}	Enable to Pad Delay through the Output Buffer—Z to High		2.78		3.17		3.72	ns
t _{ENLZ}	Enable to Pad Delay through the Output Buffer—Low to Z		1.91		1.93		1.93	ns
t _{ENHZ}	Enable to Pad Delay through the Output Buffer—High to Z		2.58		2.59		2.60	ns
t _{IOCLKQ}	Sequential Clock-to-Q for the I/O Input Register		0.67		0.77		0.90	ns
t _{IOCLKY}	Clock-to-output Y for the I/O Output Register and the I/O Enable Register		0.67		0.77		0.90	ns
t _{SUD}	Data Input Set-Up		0.23		0.27		0.31	ns
t _{SUE}	Enable Input Set-Up		0.26		0.30		0.35	ns
t _{HD}	Data Input Hold		0.00		0.00		0.00	ns
t _{HE}	Enable Input Hold		0.00		0.00		0.00	ns
t _{CPWHL}	Clock Pulse Width High to Low	0.39		0.39		0.39		ns
t _{CPWLH}	Clock Pulse Width Low to High	0.39		0.39		0.39		ns
t _{WASYN}	Asynchronous Pulse Width	0.37		0.37		0.37		ns
t _{REASYN}	Asynchronous Recovery Time		0.13		0.15		0.17	ns
t _{HASYN}	Asynchronous Removal Time		0.00		0.00		0.00	ns
t _{CLR}	Asynchronous Clear-to-Q		0.23		0.27		0.31	ns
t _{PRESET}	Asynchronous Preset-to-Q		0.23		0.27		0.31	ns

SSTL2

Stub Series Terminated Logic for 2.5 V is a general-purpose 2.5 V memory bus standard (JESD8-9). The Axcelerator devices support both classes of this standard. This requires a differential amplifier input buffer and a push-pull output buffer.

Class I

Table 2-44 • DC Input and Output Levels

VIL		VIH		VOL	VOH	IOL	IOH
Min., V	Max., V	Min., V	Max., V	Max., V	Min., V	mA	mA
-0.3	VREF - 0.2	VREF + 0.2	3.6	VREF - 0.57	VREF + 0.57	7.6	-7.6

AC Loadings

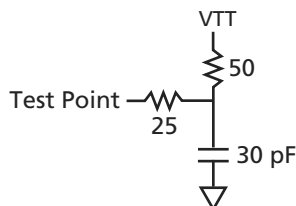


Figure 2-21 • AC Test Loads

Table 2-45 • AC Waveforms, Measuring Points, and Capacitive Loads

Input Low (V)	Input High (V)	Measuring Point* (V)	VREF (typ) (V)	C _{load} (pF)
VREF - 0.75	VREF + 0.75	VREF	1.25	30

Note: * Measuring Point = VTRIP

Timing Characteristics

Table 2-46 • 2.5 V SSTL2 Class I I/O Module

Worst-Case Commercial Conditions VCCA = 1.425 V, VCCI = 2.3 V, T_J = 70°C

		-2 Speed		-1 Speed		Std Speed		
Parameter	Description	Min.	Max.	Min.	Max.	Min.	Max.	Units
2.5 V SSTL2 Class I I/O Module Timing								
t _{DP}	Input Buffer		1.83		2.08		2.45	ns
t _{PY}	Output Buffer		2.39		2.72		3.20	ns
t _{CLKQ}	Clock-to-Q for the I/O input register		0.67		0.77		0.90	ns
t _{OCLKQ}	Clock-to-Q for the I/O output register and the I/O enable register		0.67		0.77		0.90	ns
t _{SUD}	Data Input Set-Up		0.23		0.27		0.31	ns
t _{SUE}	Enable Input Set-Up		0.26		0.30		0.35	ns
t _{HD}	Data Input Hold		0.00		0.00		0.00	ns
t _{HE}	Enable Input Hold		0.00		0.00		0.00	ns
t _{CPWHL}	Clock Pulse Width High to Low	0.39		0.39		0.39		ns
t _{CPWLH}	Clock Pulse Width Low to High	0.39		0.39		0.39		ns
t _{WASYN}	Asynchronous Pulse Width	0.37		0.37		0.37		ns
t _{REASYN}	Asynchronous Recovery Time		0.13		0.15		0.17	ns
t _{HASYN}	Asynchronous Removal Time		0.00		0.00		0.00	ns
t _{CLR}	Asynchronous Clear-to-Q		0.23		0.27		0.31	ns
t _{PRESET}	Asynchronous Preset-to-Q		0.23		0.27		0.31	ns

SSTL3

Stub Series Terminated Logic for 3.3 V is a general-purpose 3.3 V memory bus standard (JESD8-8). The Axcelerator devices support both classes of this standard. This requires a differential amplifier input buffer and a push-pull output buffer.

Class I

Table 2-50 • DC Input and Output Levels

VIL		VIH		VOL	VOH	IOL	IOH
Min., V	Max., V	Min., V	Max., V	Max., V	Min., V	mA	mA
-0.3	VREF – 0.2	VREF + 0.2	3.6	VREF – 0.6	VREF + 0.6	8	–8

AC Loadings

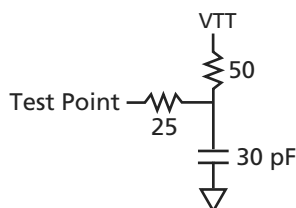


Figure 2-23 • AC Test Loads

Table 2-51 • AC Waveforms, Measuring Points, and Capacitive Loads

Input Low (V)	Input High (V)	Measuring Point* (V)	VREF (typ) (V)	C _{load} (pF)
VREF – 1.0	VREF + 1.0	VREF	1.50	30

Note: *Measuring Point = VTRIP

Timing Characteristics

Table 2-52 • 3.3 V SSTL3 Class I I/O Module

Worst-Case Commercial Conditions VCCA = 1.425 V, VCCI = 3.0 V, T_J = 70°C

		–2 Speed		–1 Speed		Std Speed		
Parameter	Description	Min.	Max.	Min.	Max.	Min.	Max.	Units
3.3 V SSTL3 Class I I/O Module Timing								
t _{DP}	Input Buffer		1.78		2.03		2.39	ns
t _{PY}	Output Buffer		2.17		2.47		2.91	ns
t _{ICKLQ}	Clock-to-Q for the I/O input register		0.67		0.77		0.90	ns
t _{OCLKQ}	Clock-to-Q for the I/O output register and the I/O enable register		0.67		0.77		0.90	ns
t _{SUD}	Data Input Set-Up		0.23		0.27		0.31	ns
t _{SUE}	Enable Input Set-Up		0.26		0.30		0.35	ns
t _{HD}	Data Input Hold		0.00		0.00		0.00	ns
t _{HE}	Enable Input Hold		0.00		0.00		0.00	ns
t _{CPWHL}	Clock Pulse Width High to Low	0.39		0.39		0.39		ns
t _{CPWLH}	Clock Pulse Width Low to High	0.39		0.39		0.39		ns
t _{WASYN}	Asynchronous Pulse Width	0.37		0.37		0.37		ns
t _{REASYN}	Asynchronous Recovery Time		0.13		0.15		0.17	ns
t _{HASYN}	Asynchronous Removal Time		0.00		0.00		0.00	ns
t _{CLR}	Asynchronous Clear-to-Q		0.23		0.27		0.31	ns
t _{PRESET}	Asynchronous Preset-to-Q		0.23		0.27		0.31	ns

Class II

Table 2-53 • DC Input and Output Levels

VIL		VIH		VOL	VOH	IOL	IOH
Min., V	Max., V	Min., V	Max., V	Max., V	Min., V	mA	mA
-0.3	VREF – 0.2	VREF + 0.2	3.6	VREF – 0.8	VREF + 0.8	16	–16

AC Loadings

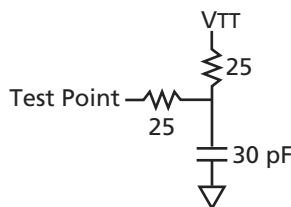


Figure 2-24 • AC Test Loads

Table 2-54 • AC Waveforms, Measuring Points, and Capacitive Loads

Input Low (V)	Input High (V)	Measuring Point* (V)	VREF (typ) (V)	C _{load} (pF)
VREF – 1.0	VREF + 1.0	VREF	1.50	30

Note: * Measuring Point = VTRIP

Timing Characteristics

Table 2-55 • 3.3 V SSTL3 Class II I/O Module

Worst-Case Commercial Conditions VCCA = 1.425 V, VCCI = 3.0V, T_J = 70°C

		–2 Speed		–1 Speed		Std Speed		
Parameter	Description	Min.	Max.	Min.	Max.	Min.	Max.	Units
3.3 V SSTL3 Class II I/O Module Timing								
t _{DP}	Input Buffer		1.85		2.10		2.47	ns
t _{PY}	Output Buffer		2.17		2.47		2.91	ns
t _{CLKQ}	Clock-to-Q for the I/O input register		0.67		0.77		0.90	ns
t _{OCLKQ}	Clock-to-Q for the I/O output register and the I/O enable register		0.67		0.77		0.90	ns
t _{SUD}	Data Input Set-Up		0.23		0.27		0.31	ns
t _{SUE}	Enable Input Set-Up		0.26		0.30		0.35	ns
t _{HD}	Data Input Hold		0.00		0.00		0.00	ns
t _{HE}	Enable Input Hold		0.00		0.00		0.00	ns
t _{CPWHL}	Clock Pulse Width High to Low	0.39		0.39		0.39		ns
t _{CPWLH}	Clock Pulse Width Low to High	0.39		0.39		0.39		ns
t _{WASYN}	Asynchronous Pulse Width	0.37		0.37		0.37		ns
t _{REASYN}	Asynchronous Recovery Time		0.13		0.15		0.17	ns
t _{HASYN}	Asynchronous Removal Time		0.00		0.00		0.00	ns
t _{CLR}	Asynchronous Clear-to-Q		0.23		0.27		0.31	ns
t _{PRESET}	Asynchronous Preset-to-Q		0.23		0.27		0.31	ns

LVPECL

Low-Voltage Positive Emitter-Coupled Logic (LVPECL) is another differential I/O standard. It requires that one data bit is carried through two signal lines. Like LVDS, two pins are needed. It also requires external resistor termination. The voltage swing between these two signal lines is approximately 850 mV.

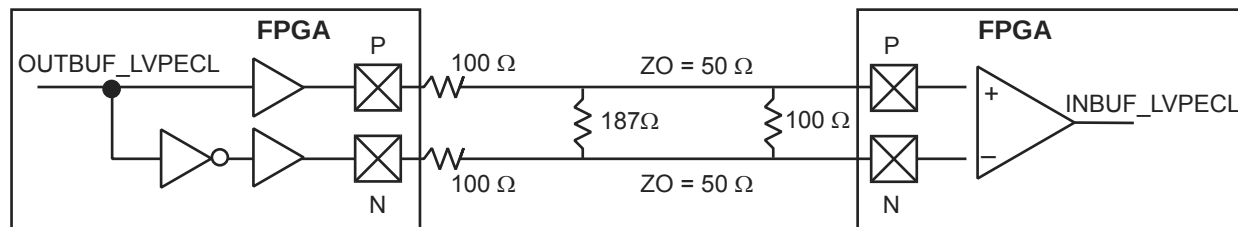


Figure 2-26 • LVPECL Board-Level Implementation

The LVPECL circuit is similar to the LVDS scheme. It requires four external resistors, three for the driver and one for the receiver. The values for the three driver resistors are different from that of LVDS since the output voltage levels are different. Please note that the VOH levels are 200 mV below the standard LVPECL levels.

Table 2-59 • DC Input and Output Levels

DC Parameter	Min.		Typ.		Max.		Units
	Min.	Max.	Min.	Max.	Min.	Max.	
VCCI	3		3.3		3.6		V
VOH	1.8	2.11	1.92	2.28	2.13	2.41	V
VOL	0.96	1.27	1.06	1.43	1.3	1.57	V
VIH	1.49	2.72	1.49	2.72	1.49	2.72	V
VIL	0.86	2.125	0.86	2.125	0.86	2.125	V
Differential Input Voltage	0.3		0.3		0.3		V

Table 2-60 • AC Waveforms, Measuring Points, and Capacitive Loads

Input Low (V)	Input High (V)	Measuring Point* (V)
1.6 – 0.3	1.6 + 0.3	1.6

Note: * Measuring Point = VTRIP

Axcelerator Clock Management System

Introduction

Each member of the Axcelerator family⁶ contains eight phase-locked loop (PLL) blocks which perform the following functions:

- Programmable Delay (32 steps of 250 ps)
- Clock Skew Minimization
- Clock Frequency Synthesis

Each PLL has the following key features:

- Input Frequency Range – 14 to 200 MHz
- Output Frequency Range – 20 MHz to 1 GHz
- Output Duty Cycle Range – 45% to 55%
- Maximum Long-Term Jitter – 1% or 100ps (whichever is greater)
- Maximum Short-Term Jitter – 50ps + 1% of Output Frequency
- Maximum Acquisition Time (lock) – 20μs

Physical Implementation

The eight PLL blocks are arranged in two groups of four. One group is located in the center of the northern edge of the chip, while the second group is centered on the southern edge. The northern group is associated with the four HCLK networks (e.g. PLLA can drive HCLKA), while the southern group is associated with the four CLK networks (e.g. PLLE can drive CLKE).

Each PLL cell is connected to two I/O pads and a PLL Cluster that interfaces with the FPGA core. Figure 2-48 illustrates a PLL block. The VCCPLL pin should be connected to a 1.5V power supply through a 250 Ω resistor. Furthermore, 0.1 μF and 10 μF decoupling capacitors should be connected across the VCCPLL and VCOMPPLL pins.

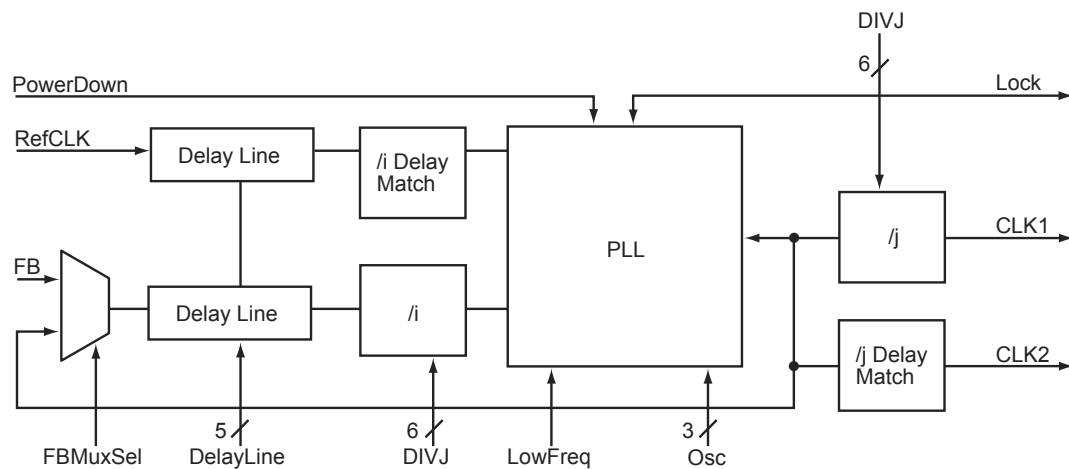


Figure 2-48 • PLL Block Diagram

Note: The VCOMPPLL pin should never be grounded (Figure 2-2 on page 2-9)!

The I/O pads associated with the PLL can also be configured for regular I/O functions except when it is used as a clock buffer. The I/O pads can be configured in all the modes available to the regular I/O pads in the same I/O bank. In particular, the [H]CLKxP pad can be configured as a differential pair,

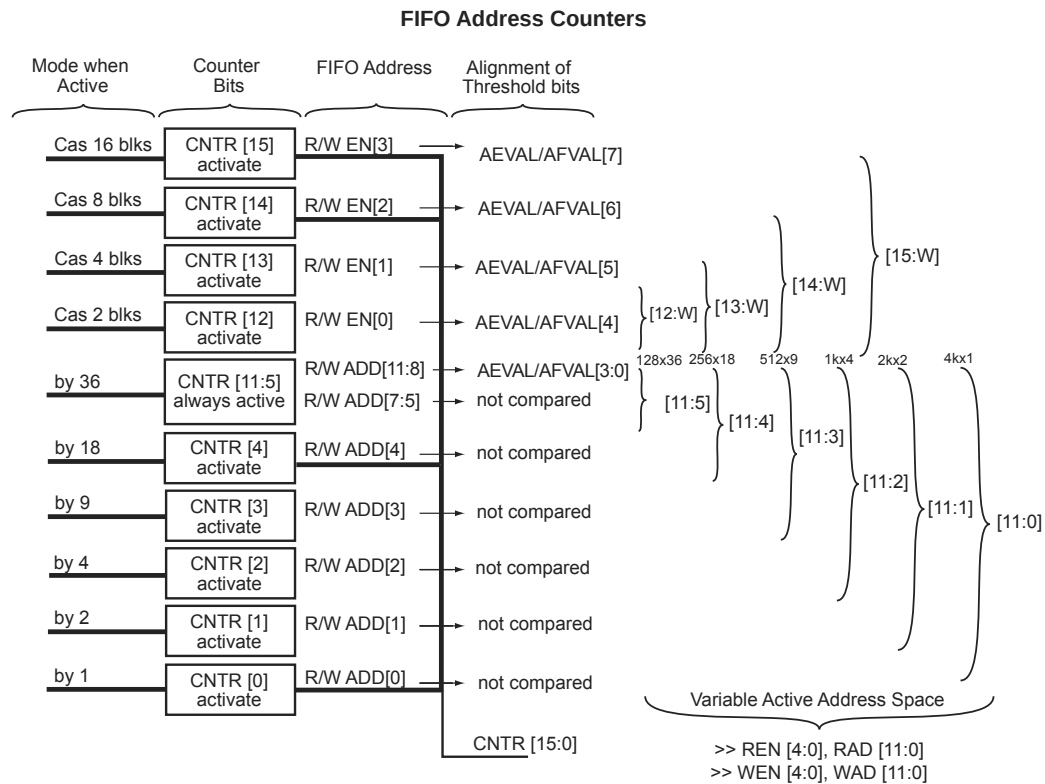
6. AX2000-CQ256 does not support operation of the phase-locked loops. This is in order to support full pin compatibility with RTAX2000S/SL-CQ256.

FIFO Flag Logic

The FIFO is user configurable into various DEPTHS and WIDTHS. Figure 2-62 shows the FIFO address counter details.

- Bits 11 to 5 are active for all modes.
- As the data word size is reduced, more least-significant bits are added to the address.
- As the number of cascaded blocks increases, the number of significant bits in the address increases.

For example, if four blocks are cascaded as a 1kx16 FIFO with each block having a 1kx4 aspect ratio, bits 11 to 2 of the address will be used to specify locations within each RAM block, whereas bits 13 and 12 will be used to specify the RAM block.



Note: Inactive counter bits are set to zero.

Figure 2-62 • FIFO Address Counters

The AFULL and AEMPTY flag threshold values are programmable. The threshold values are AFVAL and AEVAL, respectively. Although the trigger threshold for each flag is defined with eight bits, the effective number of threshold bits in the comparison depends on the configuration. The effective number of threshold bits corresponds to the range of active bits in the FIFO address space (Table 2-94).

Table 2-94 • FIFO Flag Logic

Mode	Inactive AEVAL/AFVAL Bits	Inactive DIFF Bits (set to 0)	DIFF Comparison to AFVAL/AEVAL
Non-cascade	[7:4]	[15:12]	DIFF[11:8] with AE/FVAL[3:0]
Cascade 2 blocks	[7:5]	[15:13]	DIFF[12:8] with AE/FVAL[4:0]
Cascade 4 blocks	[7:6]	[15:14]	DIFF[13:8] with AE/FVAL[5:0]
Cascade 8 blocks	[7]	[15]	DIFF[14:8] with AE/FVAL[6:0]
Cascade 16 blocks	None	None	DIFF[15:8] with AE/FVAL[7:0]

Table 2-98 • One FIFO Block

Worst-Case Commercial Conditions VCCA = 1.425 V, VCCI = 3.0 V, T_J = 70°C

		–2 Speed		–1 Speed		Std Speed		Units
Parameter	Description	Min.	Max.	Min.	Max.	Min.	Max.	
FIFO Module Timing								
t _{WSU}	Write Setup		11.40		12.98		15.26	ns
t _{WHD}	Write Hold		0.22		0.25		0.30	ns
t _{WCKH}	WCLK High		0.75		0.75		0.75	ns
t _{WCKL}	WCLK Low		0.88		0.88		0.88	ns
t _{WCKP}	Minimum WCLK Period	1.63		1.63		1.63		ns
t _{RSU}	Read Setup		11.63		13.25		15.58	ns
t _{RHD}	Read Hold		0.00		0.00		0.00	ns
t _{RCKH}	RCLK High		0.77		0.77		0.77	ns
t _{RCKL}	RCLK Low		0.93		0.93		0.93	ns
t _{RCKP}	Minimum RCLK period	1.70		1.70		1.70		ns
t _{CLRHF}	Clear High		0.00		0.00		0.00	ns
t _{CLR2FF}	Clear-to-flag (EMPTY/FULL)		1.92		2.18		2.57	ns
t _{CLR2AF}	Clear-to-flag (AEMPTY/AFULL)		4.39		5.00		5.88	ns
t _{CK2FF}	Clock-to-flag (EMPTY/FULL)		2.13		2.42		2.85	ns
t _{CK2AF}	Clock-to-flag (AEMPTY/AFULL)		5.04		5.75		6.75	ns
t _{RCK2RD1}	RCLK-To-OUT (Pipelined)		1.32		1.51		1.77	ns
t _{RCK2RD2}	RCLK-To-OUT (Non-Pipelined)		2.16		2.46		2.90	ns

Note: Timing data for this single block FIFO has a depth of 4,096. For all other combinations, use Microsemi's timing software.

FG484		FG484		FG484	
AX250 Function	Pin Number	AX250 Function	Pin Number	AX250 Function	Pin Number
Bank 0		IO17NB1F1	B14	IO34PB2F2	D22
IO00NB0F0	D7	IO17PB1F1	B13	IO35NB2F2	J18
IO00PB0F0	D6	IO18NB1F1	A14	IO35PB2F2	H18
IO01NB0F0	E7	IO18PB1F1	A13	IO36NB2F2	G21
IO01PB0F0	E6	IO19NB1F1	A16	IO36PB2F2	F21
IO02NB0F0	C5	IO19PB1F1	A15	IO37NB2F2	K19
IO02PB0F0	C4	IO20NB1F1	B16	IO37PB2F2	J19
IO03NB0F0	C7	IO20PB1F1	B15	IO38NB2F2	J20
IO03PB0F0	C6	IO21NB1F1	C17	IO38PB2F2	H20
IO04NB0F0	E9	IO21PB1F1	C16	IO39NB2F2	L16
IO04PB0F0	E8	IO22NB1F1	F15	IO39PB2F2	K16
IO05NB0F0	D9	IO22PB1F1	F14	IO40NB2F2	J21
IO05PB0F0	D8	IO23NB1F1	D16	IO40PB2F2	H21
IO06NB0F0	B7	IO23PB1F1	D15	IO41NB2F2	L17
IO06PB0F0	B6	IO24NB1F1	E16	IO41PB2F2	K17
IO07NB0F0	C9	IO24PB1F1	E15	IO42NB2F2	J22
IO07PB0F0	C8	IO25NB1F1	F18	IO42PB2F2	H22
IO08NB0F0	A7	IO25PB1F1	F17	IO43NB2F2	L18
IO08PB0F0	A6	IO26NB1F1	D18	IO43PB2F2	K18
IO09NB0F0	B9	IO26PB1F1	E17	IO44NB2F2	L20
IO09PB0F0	B8	IO27NB1F1	G16	IO44PB2F2	K20
IO10NB0F0	A9	IO27PB1F1	G15	Bank 3	
IO10PB0F0	A8	Bank 2		IO45NB3F3	M19
IO11NB0F0	B10	IO28NB2F2	F19	IO45PB3F3	L19
IO11PB0F0	A10	IO28PB2F2	E19	IO46NB3F3	M21
IO12NB0F0/HCLKAN	E11	IO29NB2F2	J16	IO46PB3F3	L21
IO12PB0F0/HCLKAP	E10	IO29PB2F2	H16	IO47NB3F3	N17
IO13NB0F0/HCLKBN	D12	IO30NB2F2	E20	IO47PB3F3	M17
IO13PB0F0/HCLKBP	D11	IO30PB2F2	D20	IO48NB3F3	N18
Bank 1		IO31NB2F2	J17	IO48PB3F3	N19
IO14NB1F1/HCLKCN	F13	IO31PB2F2	H17	IO49NB3F3	N16
IO14PB1F1/HCLKCP	F12	IO32NB2F2	G20	IO49PB3F3	M16
IO15NB1F1/HCLKDN	E14	IO32PB2F2	F20	IO50NB3F3	N20
IO15PB1F1/HCLKDP	E13	IO33NB2F2	H19	IO50PB3F3	M20
IO16NB1F1	C13	IO33PB2F2	G19	IO51NB3F3	P21
IO16PB1F1	C12	IO34NB2F2	E22	IO51PB3F3	N21

FG484		FG484		FG484	
AX250 Function	Pin Number	AX250 Function	Pin Number	AX250 Function	Pin Number
IO52NB3F3	P18	IO69PB4F4	AA17	IO87NB5F5	Y4
IO52PB3F3	P19	IO70NB4F4	AB14	IO87PB5F5	Y5
IO53NB3F3	R20	IO70PB4F4	AB15	IO88NB5F5	V6
IO53PB3F3	P20	IO71NB4F4	Y14	IO88PB5F5	V7
IO54NB3F3	T21	IO71PB4F4	W14	IO89NB5F5	T7
IO54PB3F3	R21	IO72NB4F4	AA14	IO89PB5F5	T8
IO55NB3F3	R17	IO72PB4F4	AA15	Bank 6	
IO55PB3F3	P17	IO73NB4F4	AA13	IO90NB6F6	V4
IO56NB3F3	U20	IO73PB4F4	AB13	IO90PB6F6	W5
IO56PB3F3	T20	IO74NB4F4/CLKEN	V12	IO91NB6F6	P7
IO57NB3F3	T18	IO74PB4F4/CLKEP	V13	IO91PB6F6	R7
IO57PB3F3	R18	IO75NB4F4/CLKFN	W11	IO92NB6F6	U5
IO58NB3F3	U19	IO75PB4F4/CLKFP	W12	IO92PB6F6	T5
IO58PB3F3	T19	Bank 5		IO93NB6F6	P6
IO59NB3F3	R16	IO76NB5F5/CLKGN	U10	IO93PB6F6	R6
IO59PB3F3	P16	IO76PB5F5/CLKGP	U11	IO94NB6F6	T4
IO60NB3F3	W20	IO77NB5F5/CLKHN	V9	IO94PB6F6	U4
IO60PB3F3	V20	IO77PB5F5/CLKHP	V10	IO95NB6F6	P5
IO61NB3F3	U18	IO78NB5F5	AA9	IO95PB6F6	R5
IO61PB3F3	V19	IO78PB5F5	AA10	IO96NB6F6	T3
Bank 4		IO79NB5F5	AB9	IO96PB6F6	U3
IO62NB4F4	T15	IO79PB5F5	AB10	IO97NB6F6	P3
IO62PB4F4	T16	IO80NB5F5	AA7	IO97PB6F6	R3
IO63NB4F4	W17	IO80PB5F5	AA8	IO98NB6F6	R2
IO63PB4F4	V17	IO81NB5F5	W8	IO98PB6F6	T2
IO64NB4F4	V15	IO81PB5F5	W9	IO99NB6F6	P4
IO64PB4F4	V16	IO82NB5F5	AB5	IO99PB6F6	R4
IO65NB4F4	Y19	IO82PB5F5	AB6	IO100NB6F6	P1
IO65PB4F4	W18	IO83NB5F5	AA5	IO100PB6F6	R1
IO66NB4F4	AB18	IO83PB5F5	AA6	IO101NB6F6	M7
IO66PB4F4	AB19	IO84NB5F5	U8	IO101PB6F6	N7
IO67NB4F4	W15	IO84PB5F5	U9	IO102NB6F6	N2
IO67PB4F4	W16	IO85NB5F5	Y6	IO102PB6F6	P2
IO68NB4F4	U14	IO85PB5F5	Y7	IO103NB6F6	M6
IO68PB4F4	U15	IO86NB5F5	W6	IO103PB6F6	N6
IO69NB4F4	AA16	IO86PB5F5	W7	IO104NB6F6	M4

FG676		FG676		FG676	
AX500 Function	Pin Number	AX500 Function	Pin Number	AX500 Function	Pin Number
IO153PB7F14	M6	GND	A8	GND	L11
IO154NB7F14	K2	GND	AC23	GND	L12
IO154PB7F14	L2	GND	AC4	GND	L13
IO155NB7F14	K3	GND	AD24	GND	L14
IO155PB7F14	L3	GND	AD3	GND	L15
IO156NB7F14	L5	GND	AE2	GND	L16
IO156PB7F14	L4	GND	AE25	GND	L17
IO157NB7F14	L6	GND	AF1	GND	M10
IO157PB7F14	L7	GND	AF13	GND	M11
IO158NB7F15	J1	GND	AF14	GND	M12
IO158PB7F15	K1	GND	AF19	GND	M13
IO159NB7F15	J4	GND	AF26	GND	M14
IO159PB7F15	K4	GND	AF8	GND	M15
IO160NB7F15	H2	GND	B2	GND	M16
IO160PB7F15	J2	GND	B25	GND	M17
IO161NB7F15	K6	GND	B26	GND	N1
IO161PB7F15	K5	GND	C24	GND	N10
IO162NB7F15	H3	GND	C3	GND	N11
IO162PB7F15	J3	GND	G20	GND	N12
IO163NB7F15	G2	GND	G7	GND	N13
IO163PB7F15	G1	GND	H1	GND	N14
IO164NB7F15	G4	GND	H19	GND	N15
IO164PB7F15	H4	GND	H26	GND	N16
IO165NB7F15	F3	GND	H8	GND	N17
IO165PB7F15	G3	GND	J18	GND	N26
IO166NB7F15	E2	GND	J9	GND	P1
IO166PB7F15	F2	GND	K10	GND	P10
IO167NB7F15	F5	GND	K11	GND	P11
IO167PB7F15	G5	GND	K12	GND	P12
Dedicated I/O		GND	K13	GND	P13
GND	A1	GND	K14	GND	P14
GND	A13	GND	K15	GND	P15
GND	A14	GND	K16	GND	P16
GND	A19	GND	K17	GND	P17
GND	A26	GND	L10	GND	P26

FG1152		FG1152		FG1152	
AX2000 Function	Pin Number	AX2000 Function	Pin Number	AX2000 Function	Pin Number
IO259NB6F24	AF7	IO276PB6F25	AD2	IO294NB6F27	V10
IO259PB6F24	AG7	IO277NB6F25	AC4	IO294PB6F27	V11
IO260NB6F24	AH3	IO277PB6F25	AC3	IO295NB6F27	Y1
IO260PB6F24	AH4	IO278NB6F26	AA8	IO295PB6F27	Y2
IO261NB6F24	AH5	IO278PB6F26	AA9	IO296NB6F27	W1
IO261PB6F24	AJ5	IO279NB6F26	AB5	IO296PB6F27	W2
IO262NB6F24	AE6	IO279PB6F26	AB6	IO297NB6F27	V1
IO262PB6F24	AF6	IO280NB6F26	Y10	IO297PB6F27	V2
IO263NB6F24	AF5	IO280PB6F26	Y11	IO298NB6F27	V9
IO263PB6F24	AG5	IO281NB6F26	AB3	IO298PB6F27	V8
IO264NB6F24	AD8	IO281PB6F26	AB4	IO299NB6F27	U4
IO264PB6F24	AE8	IO282NB6F26	Y7	IO299PB6F27	V4
IO265NB6F24	AF3	IO282PB6F26	AA7	Bank 7	
IO265PB6F24	AG3	IO283NB6F26	AC2	IO300NB7F28	U10
IO266NB6F24	AC10	IO283PB6F26	AC1	IO300PB7F28	U11
IO266PB6F24	AD10	IO284NB6F26	Y9	IO301NB7F28	U2
IO267NB6F25	AD7	IO284PB6F26	Y8	IO301PB7F28	U1
IO267PB6F25	AE7	IO285NB6F26	AA5	IO302NB7F28	U6
IO268NB6F25	AD5	IO285PB6F26	AA6	IO302PB7F28	U7
IO268PB6F25	AE5	IO286NB6F26	W10	IO303NB7F28	T3
IO269NB6F25	AE4	IO286PB6F26	W11	IO303PB7F28	U3
IO269PB6F25	AF4	IO287NB6F26	AA3	IO304NB7F28	U9
IO270NB6F25	AB9	IO287PB6F26	AA4	IO304PB7F28	U8
IO270PB6F25	AC9	IO288NB6F26	W9	IO305NB7F28	R2
IO271NB6F25	AC6	IO288PB6F26	W8	IO305PB7F28	R1
IO271PB6F25	AD6	IO289NB6F27	AA1	IO306NB7F28	R4
IO272NB6F25	AB8	IO289PB6F27	AA2	IO306PB7F28	T4
IO272PB6F25	AC8	IO290NB6F27	W6	IO307NB7F28	R5
IO273NB6F25	AE1	IO290PB6F27	Y6	IO307PB7F28	T5
IO273PB6F25	AE2	IO291NB6F27	W5	IO308NB7F28	T11
IO274NB6F25	AA10	IO291PB6F27	Y5	IO308PB7F28	T10
IO274PB6F25	AB10	IO292NB6F27	V7	IO309NB7F28	T6
IO275NB6F25	AB7	IO292PB6F27	W7	IO309PB7F28	T7
IO275PB6F25	AC7	IO293NB6F27	W4	IO310NB7F29	T9
IO276NB6F25	AD1	IO293PB6F27	Y4	IO310PB7F29	T8

FG1152		FG1152		FG1152	
AX2000 Function	Pin Number	AX2000 Function	Pin Number	AX2000 Function	Pin Number
GND	AK12	GND	AN34	GND	D1
GND	AK17	GND	AN4	GND	D11
GND	AK18	GND	AN9	GND	D2
GND	AK23	GND	AP13	GND	D24
GND	AK30	GND	AP2	GND	D3
GND	AK5	GND	AP22	GND	D31
GND	AL1	GND	AP27	GND	D32
GND	AL11	GND	AP3	GND	D33
GND	AL2	GND	AP31	GND	D34
GND	AL24	GND	AP32	GND	D4
GND	AL3	GND	AP33	GND	E12
GND	AL31	GND	AP4	GND	E17
GND	AL32	GND	AP8	GND	E18
GND	AL33	GND	B1	GND	E23
GND	AL34	GND	B2	GND	E30
GND	AL4	GND	B26	GND	E5
GND	AM1	GND	B3	GND	F29
GND	AM10	GND	B31	GND	F30
GND	AM15	GND	B32	GND	F6
GND	AM2	GND	B33	GND	G28
GND	AM20	GND	B34	GND	G7
GND	AM25	GND	B4	GND	H1
GND	AM3	GND	B9	GND	H34
GND	AM31	GND	C1	GND	J2
GND	AM32	GND	C10	GND	J33
GND	AM33	GND	C15	GND	K3
GND	AM34	GND	C2	GND	K32
GND	AM4	GND	C20	GND	L11
GND	AN1	GND	C25	GND	L24
GND	AN2	GND	C3	GND	L31
GND	AN26	GND	C31	GND	L4
GND	AN3	GND	C32	GND	M12
GND	AN31	GND	C33	GND	M23
GND	AN32	GND	C34	GND	M30
GND	AN33	GND	C4	GND	M5

FG1152		FG1152		FG1152	
AX2000 Function	Pin Number	AX2000 Function	Pin Number	AX2000 Function	Pin Number
NC	AP9	PRB	F18	VCCA	T22
NC	B17	PRC	AD18	VCCA	U13
NC	B22	PRD	AH18	VCCA	U22
NC	B27	TCK	J9	VCCA	V13
NC	B8	TDI	F7	VCCA	V22
NC	D10	TDO	L10	VCCA	W13
NC	D20	TMS	H8	VCCA	W22
NC	D23	TRST	E6	VCCA	Y13
NC	D25	VCCA	AA13	VCCA	Y22
NC	F3	VCCA	AA22	VCCDA	AF26
NC	F32	VCCA	AB14	VCCDA	AF9
NC	F33	VCCA	AB15	VCCDA	AG17
NC	F34	VCCA	AB16	VCCDA	AG18
NC	F4	VCCA	AB17	VCCDA	AH14
NC	G1	VCCA	AB18	VCCDA	AH15
NC	G32	VCCA	AB19	VCCDA	AH17
NC	G33	VCCA	AB20	VCCDA	AH20
NC	G34	VCCA	AB21	VCCDA	AH21
NC	H31	VCCA	AF8	VCCDA	AK29
NC	H33	VCCA	AK28	VCCDA	AK6
NC	J1	VCCA	G30	VCCDA	E15
NC	J3	VCCA	G5	VCCDA	E29
NC	J34	VCCA	N14	VCCDA	E7
NC	M1	VCCA	N15	VCCDA	F15
NC	M4	VCCA	N16	VCCDA	F21
NC	P1	VCCA	N17	VCCDA	F5
NC	P2	VCCA	N18	VCCDA	G20
NC	R31	VCCA	N19	VCCDA	H17
NC	T1	VCCA	N20	VCCDA	H18
NC	T2	VCCA	N21	VCCDA	H28
NC	V3	VCCA	P13	VCCDA	J18
NC	V34	VCCA	P22	VCCDA	V27
NC	W3	VCCA	R13	VCCDA	V6
NC	W34	VCCA	R22	VCCIB0	A5
PRA	J17	VCCA	T13	VCCIB0	B5

PQ208	
AX500 Function	Pin Number
IO150PB7F14	19
IO152NB7F14	16
IO152PB7F14	17
IO161NB7F15	12
IO161PB7F15	13
IO163NB7F15	10
IO163PB7F15	11
IO165PB7F15	7
IO166NB7F15	5
IO166PB7F15	6
IO167NB7F15	3
IO167PB7F15	4
Dedicated I/O	
V _{CCDA}	1
V _{CCDA}	26
V _{CCDA}	53
V _{CCDA}	63
V _{CCDA}	78
V _{CCDA}	95
V _{CCDA}	105
V _{CCDA}	130
V _{CCDA}	157
V _{CCDA}	167
V _{CCDA}	182
V _{CCDA}	202
GND	104
GND	9
GND	15
GND	21
GND	32
GND	39
GND	46
GND	51
GND	59
GND	65
GND	69
GND	90

PQ208	
AX500 Function	Pin Number
GND	94
GND	99
GND	113
GND	119
GND	125
GND	143
GND	136
GND	150
GND	155
GND	164
GND	169
GND	173
GND	194
GND	196
GND	201
GND/LP	208
PRA	184
PRB	183
PRC	80
PRD	79
TCK	205
TDI	204
TDO	203
TMS	206
TRST	207
VCCA	2
VCCA	14
VCCA	38
VCCA	52
VCCA	64
VCCA	93
VCCA	118
VCCA	142
VCCA	156
VCCA	168
VCCA	195
VCCPLA	189

PQ208	
AX500 Function	Pin Number
VCCPLB	187
VCCPLC	178
VCCPLD	176
VCCPLE	85
VCCPLF	83
VCCPLG	74
VCCPLH	72
VCCIB0	200
VCCIB0	193
VCCIB1	172
VCCIB1	163
VCCIB2	149
VCCIB2	135
VCCIB3	124
VCCIB3	112
VCCIB4	98
VCCIB4	89
VCCIB5	68
VCCIB5	58
VCCIB6	45
VCCIB6	31
VCCIB7	20
VCCIB7	8
VCOMPLA	190
VCOMPLB	188
VCOMPLC	179
VCOMPLD	177
VCOMPLE	86
VCOMPLF	84
VCOMPLG	75
VCOMPLH	73
VPUMP	158

CQ352	
AX250 Function	Pin Number
GND	21
GND	27
GND	33
GND	39
GND	45
GND	51
GND	57
GND	63
GND	69
GND	75
GND	81
GND	88
GND	89
GND	97
GND	103
GND	109
GND	115
GND	121
GND	133
GND	145
GND	151
GND	157
GND	163
GND	169
GND	176
GND	177
GND	186
GND	192
GND	198
GND	204
GND	210
GND	216
GND	222
GND	228
GND	234

CQ352	
AX250 Function	Pin Number
GND	240
GND	246
GND	252
GND	258
GND	264
GND	265
GND	274
GND	280
GND	286
GND	292
GND	298
GND	310
GND	322
GND	330
GND	334
GND	340
GND	345
GND	352
NC	91
NC	117
NC	130
NC	131
NC	148
NC	174
NC	268
NC	294
NC	307
NC	308
NC	327
NC	328
PRA	312
PRB	311
PRC	135
PRD	134
TCK	349

CQ352	
AX250 Function	Pin Number
TDI	348
TDO	347
TMS	350
TRST	351
VCCA	3
VCCA	14
VCCA	32
VCCA	56
VCCA	74
VCCA	87
VCCA	102
VCCA	114
VCCA	150
VCCA	162
VCCA	175
VCCA	191
VCCA	209
VCCA	233
VCCA	251
VCCA	263
VCCA	279
VCCA	291
VCCA	329
VCCA	339
VCCDA	2
VCCDA	44
VCCDA	90
VCCDA	116
VCCDA	132
VCCDA	149
VCCDA	178
VCCDA	221
VCCDA	266
VCCDA	293
VCCDA	309

CQ352		CQ352		CQ352	
AX500 Function	Pin Number	AX500 Function	Pin Number	AX500 Function	Pin Number
GND	21	GND	240	TDI	348
GND	27	GND	246	TDO	347
GND	33	GND	252	TMS	350
GND	39	GND	258	TRST	351
GND	45	GND	264	VCCA	3
GND	51	GND	265	VCCA	14
GND	57	GND	274	VCCA	32
GND	63	GND	280	VCCA	56
GND	69	GND	286	VCCA	74
GND	75	GND	292	VCCA	87
GND	81	GND	298	VCCA	102
GND	88	GND	310	VCCA	114
GND	89	GND	322	VCCA	150
GND	97	GND	330	VCCA	162
GND	103	GND	334	VCCA	175
GND	109	GND	340	VCCA	191
GND	115	GND	345	VCCA	209
GND	121	GND/LP	352	VCCA	233
GND	133	NC	91	VCCA	251
GND	145	NC	117	VCCA	263
GND	151	NC	130	VCCA	279
GND	157	NC	131	VCCA	291
GND	163	NC	148	VCCA	329
GND	169	NC	174	VCCA	339
GND	176	NC	268	VCCDA	2
GND	177	NC	294	VCCDA	44
GND	186	NC	307	VCCDA	90
GND	192	NC	308	VCCDA	116
GND	198	NC	327	VCCDA	132
GND	204	NC	328	VCCDA	149
GND	210	PRA	312	VCCDA	178
GND	216	PRB	311	VCCDA	221
GND	222	PRC	135	VCCDA	266
GND	228	PRD	134	VCCDA	293
GND	234	TCK	349	VCCDA	309

Datasheet Categories

Categories

In order to provide the latest information to designers, some datasheet parameters are published before data has been fully characterized from silicon devices. The data provided for a given device, as highlighted in the "Axcelerator Family Device Status" table on page iii, is designated as either "Product Brief," "Advance," "Preliminary," or "Production." The definitions of these categories are as follows:

Product Brief

The product brief is a summarized version of a datasheet (advance or production) and contains general product information. This document gives an overview of specific device and family information.

Advance

This version contains initial estimated information based on simulation, other products, devices, or speed grades. This information can be used as estimates, but not for production. This label only applies to the DC and Switching Characteristics chapter of the datasheet and will only be used when the data has not been fully characterized.

Preliminary

The datasheet contains information based on simulation and/or initial characterization. The information is believed to be correct, but changes are possible.

Production

This version contains information that is considered to be final.

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